

May 2014

Dual N-Channel PowerTrench[®] MOSFET N-Channel: 30 V, 30 A, 7.5 m Ω N-Channel: 30 V, 40 A, 2.4 m Ω

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 7.5 m Ω at V_{GS} = 10 V, I_D = 12 A
- Max $r_{DS(on)}$ = 12 m Ω at V_{GS} = 4.5 V, I_D = 10 A

Q2: N-Channel

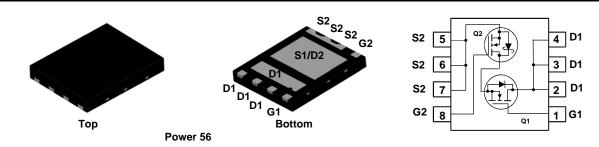
- Max $r_{DS(on)}$ = 2.4 m Ω at V_{GS} = 10 V, I_D = 20 A
- Max $r_{DS(on)}$ = 2.9 m Ω at V_{GS} = 4.5 V, I_D = 18 A
- RoHS Compliant

General Description

This device includes two specialized N-Channel MOSFETs in a dual MLP package. The switch node has been internally connected to enable easy placement and routing of synchronous buck converters. The control MOSFET (Q1) and synchronous SyncFETTM (Q2) have been designed to provide optimal power efficiency.

Applications

- Computing
- Communications
- General Purpose Point of Load
- Notebook VCORE



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units	
V _{DS}	Drain to Source Voltage		30	30	V	
V _{GS}	Gate to Source Voltage	(Note 3)	±20	±20	V	
	Drain Current -Continuous	T _C = 25 °C	30	40		
I _D	-Continuous	T _A = 25 °C	12 ^{1a}	22 ^{1b}	А	
	-Pulsed		40	60	1	
Р	Power Dissipation for Single Operation	T _A = 25 °C	2.2 ^{1a}	2.5 ^{1b}	10/	
P _D		T _A = 25 °C	1.0 ^{1c}	1.0 ^{1d}	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			+150	°C	

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	57 ^{1a}	50 ^{1b}	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	125 ^{1c}	120 ^{1d}	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case 3.5		2	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7700S	FDMS7700S	Power 56	13 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$ $I_D = 1 \ m A, \ V_{GS} = 0 \ V$	Q1 Q2	30 30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 1 \ m$ A, referenced to 25 °C	Q1 Q2		15 14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V	Q1 Q2			1 500	μΑ μΑ
I _{GSS}	Gate to Source Leakage Current	V _{GS} = 20 V, V _{DS} = 0 V	Q1 Q2			100 100	nA nA
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$ $V_{GS} = V_{DS}, I_D = 1 \ m A$	Q1 Q2	1 1	1.8 1.5	3 3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 1 \ m$ A, referenced to 25 °C	Q1 Q2		-6 -4		mV/°C
_	Droin to Source On Desister		Q1		6.0 8.5 8.3	7.5 12 12	
r _{DS(on)} Drain	Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 18 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125 ^{\circ}\text{C}$	Q2		1.9 2.2 2.1	2.4 2.9 3.4	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_D = 12 A$ $V_{DS} = 5 V, I_D = 20 A$	Q1 Q2		63 160		S

Dynamic Characteristics

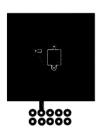
C _{iss}	Input Capacitance	Q1: V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHZ	Q1 Q2	1315 7240	1750 9630	pF
C _{oss}	Output Capacitance	Q2:	Q1 Q2	445 2690	600 3580	pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHZ	Q1 Q2	45 185	70 280	pF
R _g	Gate Resistance		Q1 Q2	0.9 0.8		Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time	_		Q1 Q2	8.6 21	18 34	ns
t _r	Rise Time		Q1: $V_{DD} = 15 \text{ V}, \text{ I}_{D} = 12 \text{ A}, \text{ R}_{GEN} = 6 \Omega$ Q2: $V_{DD} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ R}_{GEN} = 6 \Omega$		2.5 9.2	10 18	ns
t _{d(off)}	Turn-Off Delay Time				20 58	32 93	ns
t _f	Fall Time	VDD - 13 V, ID - 20			2.3 6.8	10 14	ns
Qg	Total Gate Charge	$V_{GS} = 0$ V to 10 V		Q1 Q2	20 105	28 147	nC
Qg	Total Gate Charge	$V_{GS} = 0$ V to 4.5 V	V _{DD} = 15 V, I _D = 12 A	Q1 Q2	9.3 48	13 67	nC
Q _{gs}	Gate to Source Gate Charge		Q2 V _{DD} = 15 V,	Q1 Q2	4.3 19		nC
Q _{gd}	Gate to Drain "Miller" Charge		$V_{DD} = 13 V,$ $I_{D} = 20 A$	Q1 Q2	2.2 11		nC

Electrica	Electrical Characteristics T _J = 25 °C unless otherwise noted								
Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units		
Drain-Soເ	Irce Diode Characteristics								
V _{SD}	Source to Drain Diode Forward Voltage		,		0.8 0.7	1.2 1.2	V		
t _{rr}	Reverse Recovery Time	Q1 I _F = 12 A, di/dt = 100 A/µs	Q1 Q2		27 53	43 85	ns		
Q _{rr}	Reverse Recovery Charge	Q2 Ι _F = 20 A, di/dt = 300 A/μs	Q1 Q2		10 100	18 160	nC		

Notes: 1: R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.





a. 57 °C/W when mounted on a 1 in² pad of 2 oz copper

c. 125 °C/W when mounted on a minimum pad of 2 oz copper



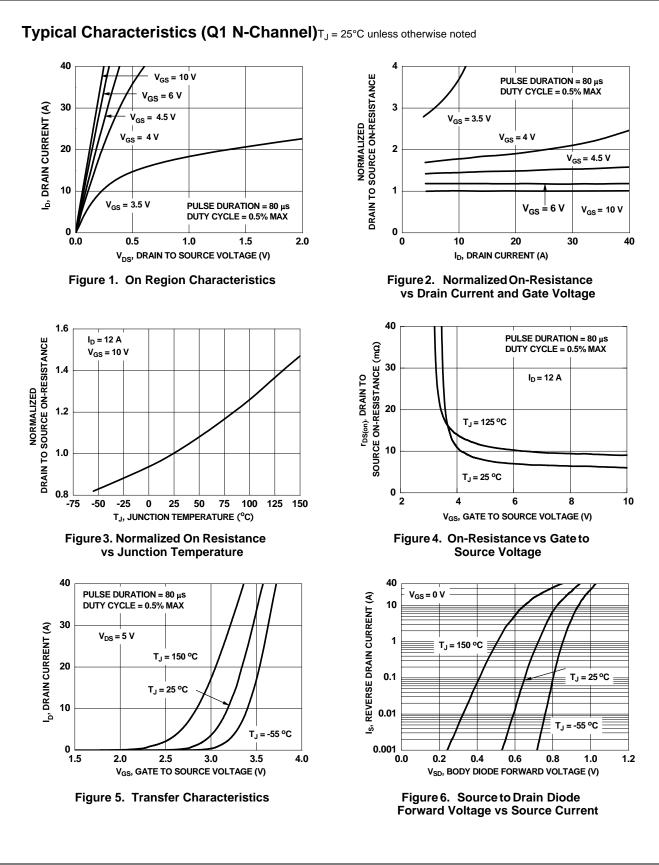
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d. 120 °C/W when mounted on a minimum pad of 2 oz copper

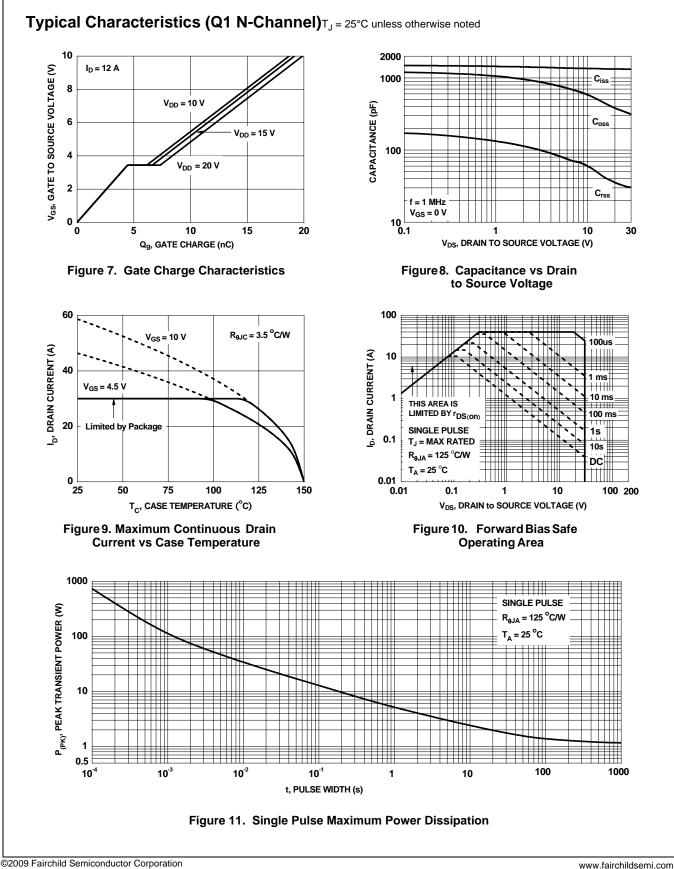
b. 50 °C/W when mounted on a 1 in² pad of 2 oz copper

2: Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

3: As an N-ch device, the negative Vgs rating is for low duty cycle pulse ocurrence only. No continuous rating is implied.

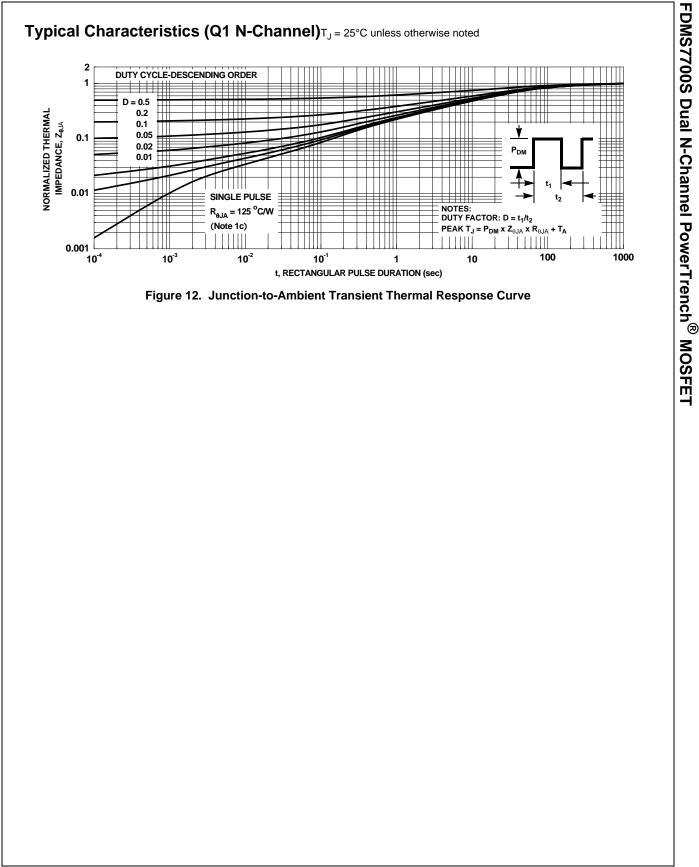


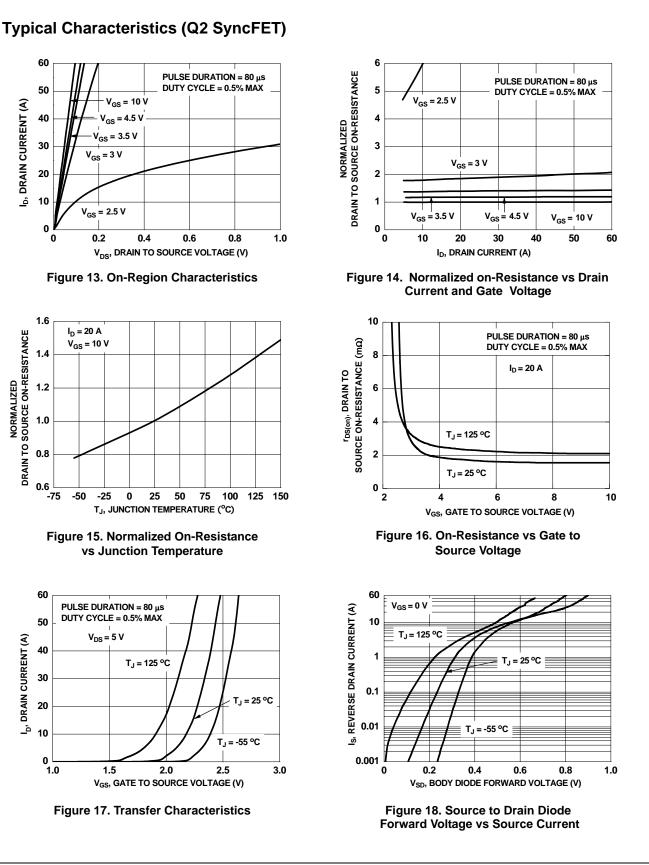
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FDMS7700S Rev.C1

FDMS7700S Dual N-Channel PowerTrench[®] MOSFET

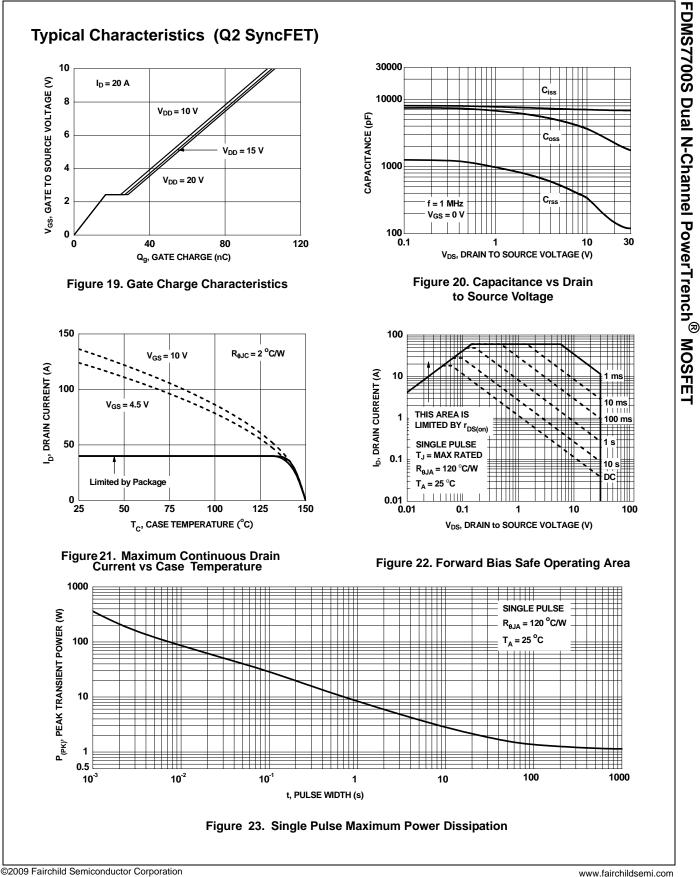




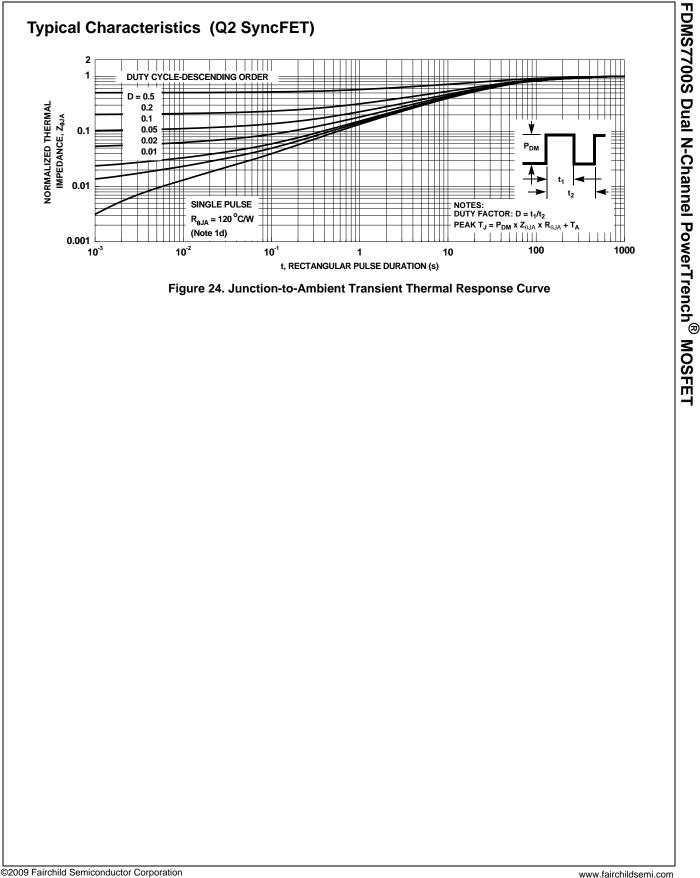
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FDMS7700S Dual N-Channel PowerTrench[®] MOSFET



FDMS7700S Rev.C1



FDMS7700S Rev.C1

FDMS7700S Dual N-Channel PowerTrench[®] MOSFET

Typical Characteristics (continued)

SyncFET[™] Schottky Body Diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench[®] MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 25 shows the reverse recovery characteristic of the FDMS7700S.

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Figure 25. FDMS7700S SyncFET[™] Body Diode Reverse Recovery Characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

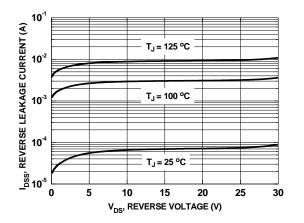
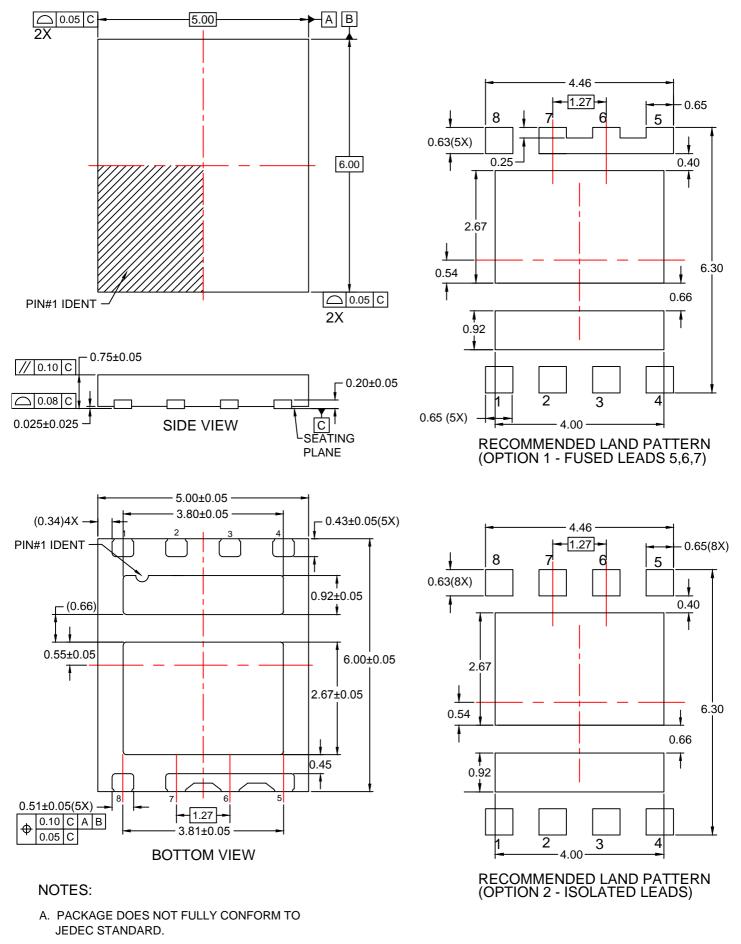
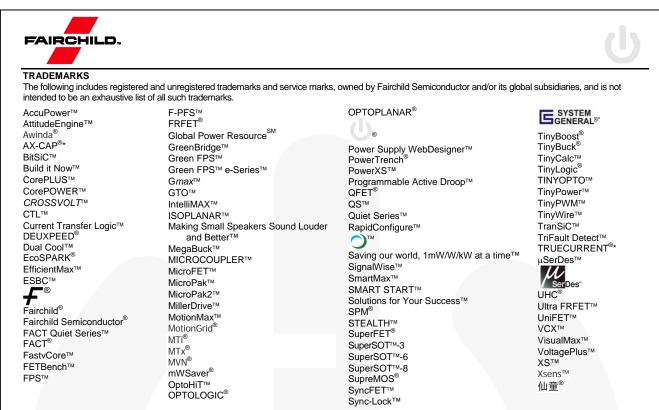


Figure 26. SyncFETTM Body Diode Reverse Leakage vs. Drain-Source Voltage



- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
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